#### TOSHIBA PHOTOCOUPLER GaAIAs IRED & PHOTO-TRIAC

# **TLP3064(S)**

OFFICE MACHINE
HOUSEHOLD USE EQUIPMENT
TRIAC DRIVER
SOLID STATE RELAY

The TOSHIBA TLP3064(S) consists of a zero voltage crossing turn-on photo-triac optically coupled to a GaAlAs infrared emitting diode in a six lead plastic DIP package.

Peak Off-State Voltage : 600 V(Min)
 Trigger LED Current : 3 mA(Max)
 On-State Current : 100 mA(Max)
 Isolation Voltage : 5000 Vrms(Min)

• UL Recognized : UL1577,File No.E67349

• SEMKO Approved : SS EN60065

SS EN60950, File No.9841113

• BSI Approved : BS EN60065, File No.8385

BS EN60950, File No.8386

• Option (D4) type

VDE approved: DIN EN60747-5-2

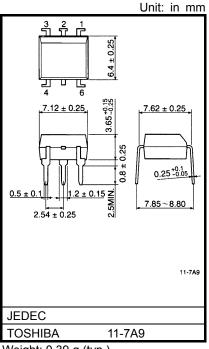
Approved No. 40009302

Maximum operating insulation voltage: 890 VpK Highest permissible over voltage: 8000 VpK

(Note):When a EN60747-5-2 approved type is needed, please designate the "Option (D4)"

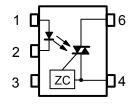
#### Construction Mechanical Rating

	7.62 mm pitch Standard Type	10.16 mm pitch TLPxxxxF Type
Creepage Distance	7.0 mm (Min)	8.0 mm (Min)
Clearance	7.0 mm (Min)	8.0 mm (Min)
Insulation Thickness	0.5 mm (Min)	0.5 mm (Min)



Weight: 0.39 g (typ.)

# Pin Configuration (top view)



- 1: Anode
- 2: Cathode
- 3: N.C.
- 4:Terminal 1
- 6:Terminal 2

ZC:Zero-cross Circuit



### Absolute Maximum Ratings (Ta = 25°C)

	CHARACTERISTIC			RATING	UNIT	
	Forward Current	ΙF	30	mA		
LED	Forward Current Derating (Ta ≥ 25°C)	ΔI <sub>F</sub> /°C	-0.3	mA /°C		
	Peak Forward Current (100 μs pulse, 100 pps)	IFP	1	Α		
	Reverse Voltage	V <sub>R</sub>	5	V		
	Junction Temperature	Tj	125	°C		
	Off-State Output Terminal Voltage	$V_{DRM}$	600	V		
	On-State RMS Current	Ta = 25°C	IT/DMC)	100	mA	
OR.	on-otate rivio outrent	Ta = 70°C	I <sub>T(RMS)</sub>	50		
DETECTOR	On-State Current Derating (Ta ≥ 25°C)	ΔI <sub>T</sub> /°C	-1.1	mA /°C		
E.	Peak On-State Current (100 μs pulse, 120 pps)	I <sub>TP</sub>	2	Α		
	Peak Nonrepetitive Surge Current (Pw = 10 ms)	I <sub>TSM</sub>	1.2	Α		
	Junction Temperature	Tj	115	°C		
Stor	rage Temperature Range	T <sub>stg</sub>	-55 to 150	°C		
Оре	Operating Temperature Range			-40 to 100	°C	
Lea	Lead Soldering Temperature (10 s)			260	°C	
Isola	Isolation Voltage (AC, 1 min., R.H.≤60%) (Note 2)			5000	Vrms	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

(Note 2) Device considered a two terminal device:Pins1, 2 and 3 shorted together and pin 4 and pin 6 shorted together.

### **Recommended Operating Conditions**

CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT
Supply Voltage	V <sub>AC</sub>	_	_	240	V <sub>ac</sub>
Forward Current	lF	4.5	6	7.5	mA
Peak On-State Current	I <sub>TP</sub>	_	_	1	Α
Operating Temperature	T <sub>opr</sub>	-10	-	85	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

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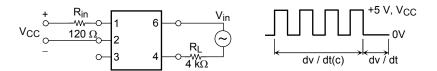
# Individual Electrical Characteristics (Ta=25°C)

	CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
	Forward Voltage	VF	I <sub>F</sub> = 10 mA	1.2	1.4	1.7	V
LED	Reverse Current	I <sub>R</sub>	V <sub>R</sub> = 3 V	_	_	10	μΑ
	Capacitance	C <sub>T</sub>	V = 0, f = 1 MHz	-	30	_	pF
	Peak Off-State Current	I <sub>DRM</sub>	V <sub>DRM</sub> = 600 V		10	1000	nA
꼰	Peak On-State Voltage	V <sub>TM</sub>	I <sub>TM</sub> = 100 mA		_	3.0	V
CTOR	Holding Current	lΗ	_	_	0.6	_	mA
DETE	Critical Rate of Rise of Off-State Voltage	dv / dt	Vin = 240 Vrms, Ta = 85°C (Fig.1)	200	500	_	V/μs
	Critical Rate of Rise of Commutating Voltage	dv / dt(c)	Vin = 60 Vrms, I <sub>T</sub> = 15 mA (Fig.1)	_	0.2	_	V/μs

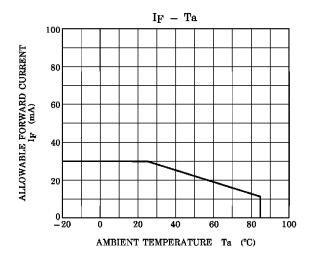
## **Coupled Electrical Characteristics (Ta=25°C)**

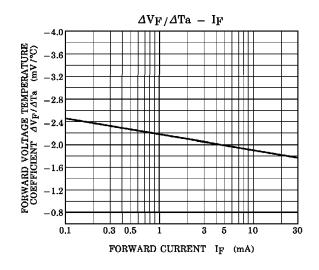
CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Trigger LED Current	I <sub>FT</sub>	V <sub>T</sub> = 3 V ,Resistive Load	_	_	3	mA
Inhibit Voltage	V <sub>IH</sub>	I <sub>F</sub> = Rated I <sub>FT</sub>	_	_	50	V
Leakage in Inhibited State	l <sub>IH</sub>	I <sub>F</sub> = Rated I <sub>FT</sub> , V <sub>T</sub> = Rated V <sub>DRM</sub>	_	_	600	μА
Capacitance (Input to Output)	CS	V <sub>S</sub> =0, f=1 MHz	_	0.8	_	pF
Isolation Resistance	R <sub>S</sub>	V <sub>S</sub> = 500 V, R.H.≤60%	1×10 <sup>12</sup>	10 <sup>14</sup>	_	Ω
	BVS	AC, 1 minute	5000	_	_	Vrms
Isolation Voltage		AC, 1 second, in oil	_	10000	_	
		DC, 1 minute, in oil	_	10000	_	Vdc

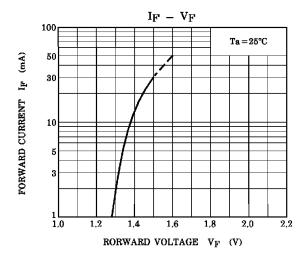
Fig. 1 dv / dt test circuit

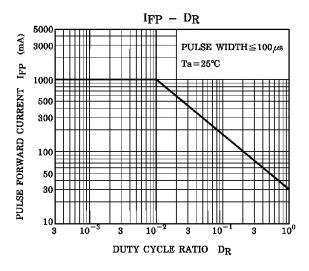


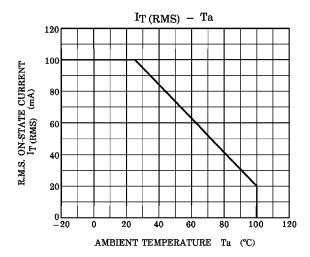
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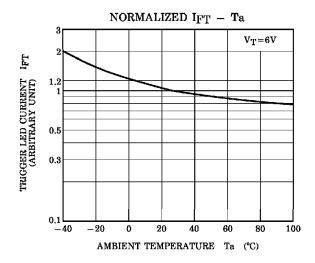


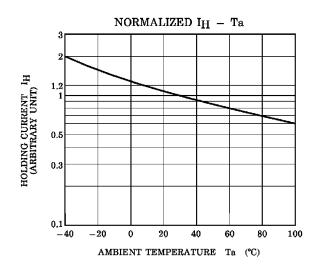


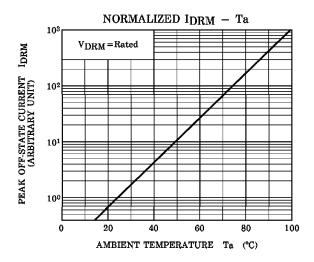


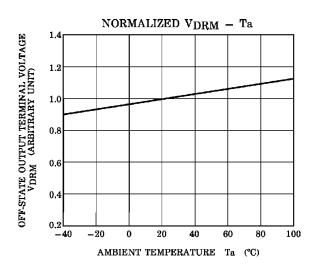


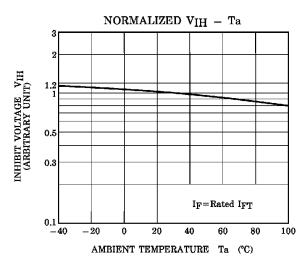


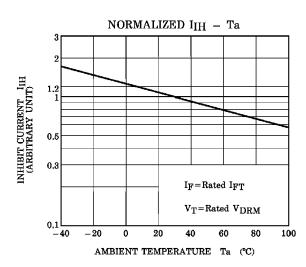












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